

## Electronic Patent Application Fee Transmittal

<b>Application Number:</b>				
<b>Filing Date:</b>				
<b>Title of Invention:</b>	RESIN COMPOSITION, MOLDED PRODUCT FROM RESIN COMPOSITION AND METHOD FOR PREPARING RESIN COMPOSITION			
<b>First Named Inventor:</b>	Takeshi Horie			
<b>Filer:</b>	David Richard Metzger/Barbara Hannon			
<b>Attorney Docket Number:</b>	09792909-6708			
Filed as Large Entity				
<b>U.S. National Stage under 35 USC 371 Filing Fees</b>				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Basic Filing:</b>				
National Stage Fee	1631	1	300	300
National Stage Search - all other cases	1632	1	500	500
National Stage Exam - all other cases	1633	1	200	200
<b>Pages:</b>				
<b>Claims:</b>				
Claims in excess of 20	1615	23	50	1150
Independent claims in excess of 3	1614	9	200	1800
<b>Miscellaneous-Filing:</b>				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
<b>Petition:</b>				
<b>Patent-Appeals-and-Interference:</b>				
Post-Allowance-and-Post-Issuance:				
<b>Extension-of-Time:</b>				
<b>Miscellaneous:</b>				
<b>Total in USD (\$)</b>				<b>3950</b>